FAIRCHILD

SEMICONDUCTOR

FQT13N06 60V N-Channel MOSFET

General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for low voltage applications such as DC/DC converters, high efficiency switching for power management in portable and battery operated products.

Features

- 2.8A, 60V, $R_{DS(on)}$ = 0.14 Ω @V_{GS} = 10 V Low gate charge (typical 5.8 nC)
- Low Crss (typical 15 pF)
- Fast switching
- Improved dv/dt capability





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQT13N06	Units
V _{DSS}	Drain-Source Voltage		60	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$) - Continuous ($T_C = 70^{\circ}C$)		2.8	Α
			2.24	A
I _{DM}	Drain Current - Pulsed	(Note 1)	11.2	A
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	85	mJ
I _{AR}	Avalanche Current	(Note 1)	2.8	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	0.21	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	7.0	V/ns
PD	Power Dissipation ($T_C = 25^{\circ}C$)		2.1	W
	- Derate above 25°C		0.017	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient *		60	°C/W

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics				•	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	60			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.06		V/°C
		V _{DS} = 60 V, V _{GS} = 0 V			1	μA
	Zero Gate Voltage Drain Current	V _{DS} = 48 V, T _C = 150°C			10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 25 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -25 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			-100	nA
	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 1.4 A		0.11	0.14	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 25 \text{ V}, I_D = 1.4 \text{ A}$ (Note 4)		3.0		S
C _{iss} C _{oss} C _{rss}	ic Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz		240 90 15	310 120 20	pF pF pF
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 30 V, I _D = 6.5 A,		5	20	ns
t _r	Turn-On Rise Time	$R_{G} = 25 \Omega$		25	60	ns
t _{d(off)}	Turn-Off Delay Time			8	25	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		15	40	ns
Qg	Total Gate Charge	V _{DS} = 48 V, I _D = 13 A,		5.8	7.5	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		2.0		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		2.5		nC
Drain-S	Source Diode Characteristics a	•			2.0	
		ain-Source Diode Forward Current			2.8	A
I _{SM}	Maximum Pulsed Drain-Source Diode F				11.2	A
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.8 A$			1.5	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 13 A,$		39		ns
Q _{rr}	Reverse Recovery Charge	$dI_F / dt = 100 \text{ A/}\mu\text{s}$ (Note 4)		40		nC

4. Pulse Test : Pulse width \leq 300µcs, $P_{DD} \geq BV_{DSS}$, Statting 5. Essentially independent of operating temperature







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